

## P-Ch 30V Fast Switching MOSFETs



- ★ Super Low Gate Charge
- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

## Product Summary

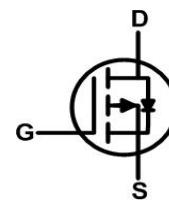
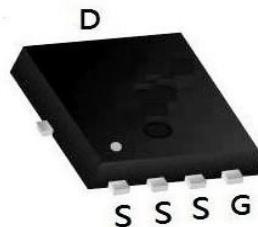
BVDSS	RDS(on)	ID
-30V	2.5mΩ	-110A

## Description

The XR110P03F is the highest performance trench P-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The XR110P03F meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

## PDFN5060-8L Pin Configuration



## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	-30	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1,6</sup>	-110	A
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1,6</sup>	-70	A
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	-450	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	576	mJ
I <sub>AS</sub>	Avalanche Current	-70	A
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	6 0	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 175	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 175	°C

## Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction-ambient <sup>1</sup> (t≤10S)	---	20	°C/W
	Thermal Resistance Junction-ambient <sup>1</sup> (Steady State)	---	50	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction-case <sup>1</sup>	---	3.6	°C/W

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Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=-250\mu\text{A}$	-30			V
$I_{\text{DS}(\text{S})}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-30\text{V}$ , $V_{\text{GS}}=0\text{V}$			-1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=-250\mu\text{A}$	-1	-1.7	-2.5	V
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=-5\text{V}$ , $I_{\text{D}}=-20\text{A}$		65		S
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-10\text{V}$ , $I_{\text{D}}=-20\text{A}$		2.5	3.1	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$ , $I_{\text{D}}=-20\text{A}$		4	5.2	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$		7000		pF
$C_{\text{oss}}$	Output Capacitance			820		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			540		pF
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1.0\text{MHz}$		2.2		$\Omega$
<b>Switching Parameters</b>						
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{GS}}=-10\text{V}$ , $V_{\text{DS}}=-15\text{V}$ , $R_L=0.75\Omega$ , $R_{\text{GEN}}=3\Omega$		14		nS
$t_r$	Turn-on Rise Time			13		nS
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time			65		nS
$t_f$	Turn-Off Fall Time			37		nS
$Q_g$	Total Gate Charge	$V_{\text{GS}}=-10\text{V}$ , $V_{\text{DS}}=-15\text{V}$ , $I_{\text{D}}=-20\text{A}$		130		nC
$Q_{\text{gs}}$	Gate-Source Charge			12		nC
$Q_{\text{gd}}$	Gate-Drain Charge			31		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{\text{SD}}$	Source-Drain Current (Body Diode)				-108	A
$V_{\text{SD}}$	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=-20\text{A}$			-1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_F=-20\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$		30		ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$I_F=-20\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$		40		nC

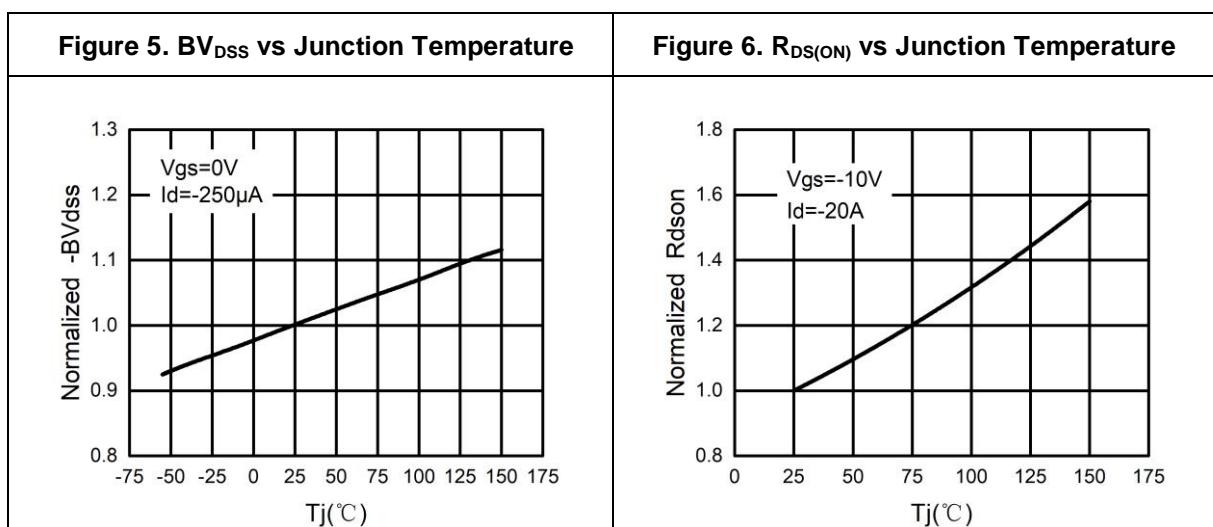
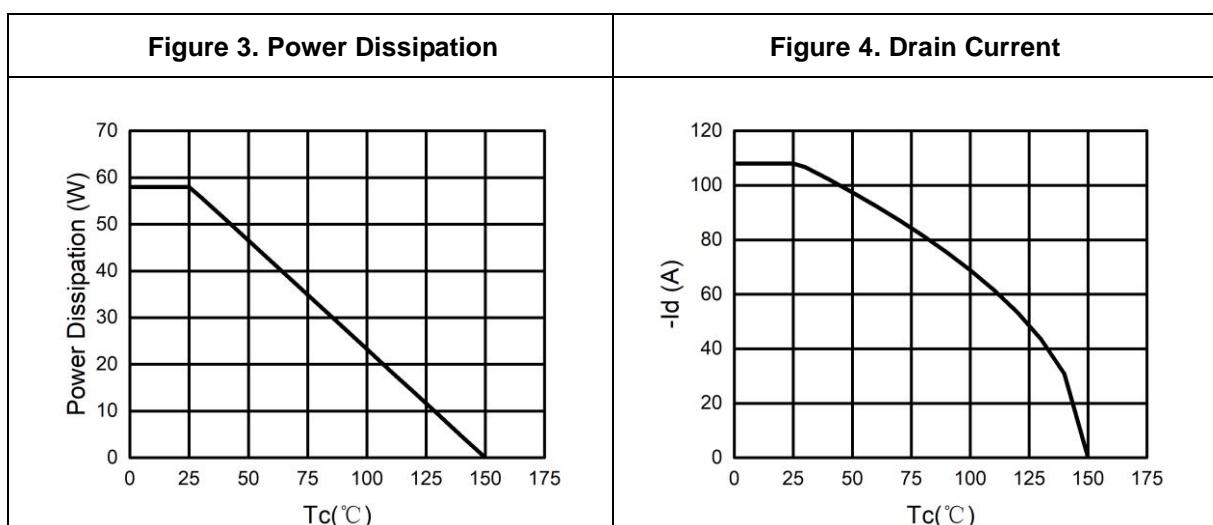
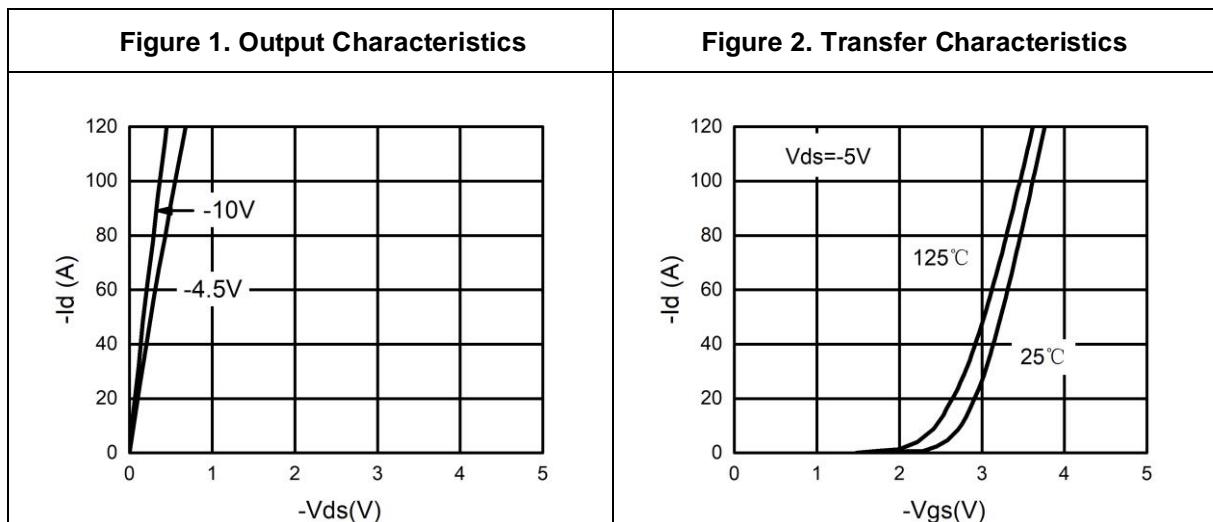
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

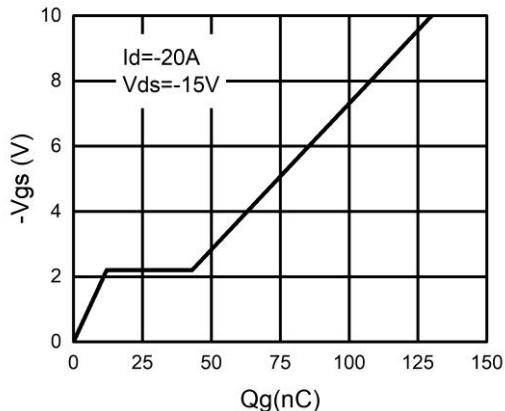
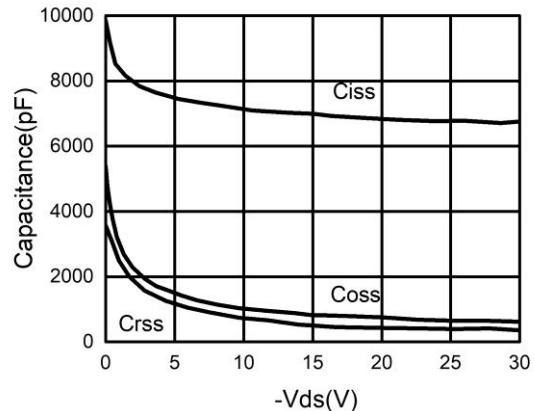
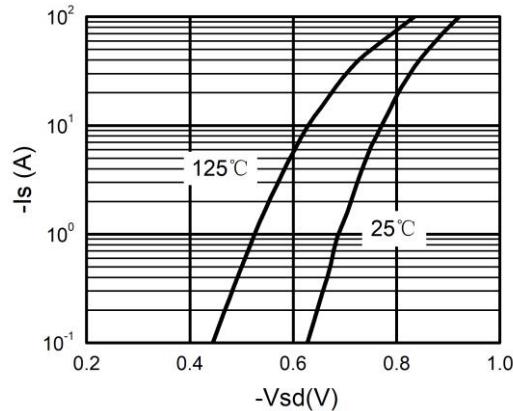
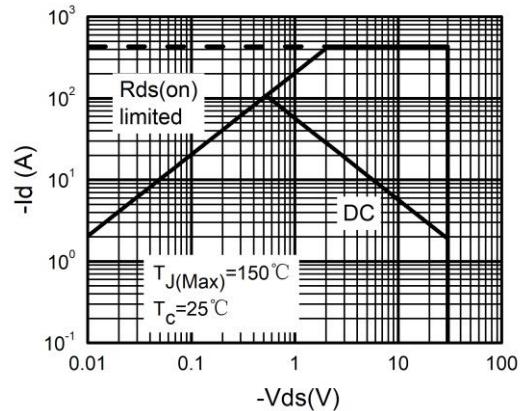
Notes 2.EAS condition:  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=15\text{V}$ ,  $V_G=-10\text{V}$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

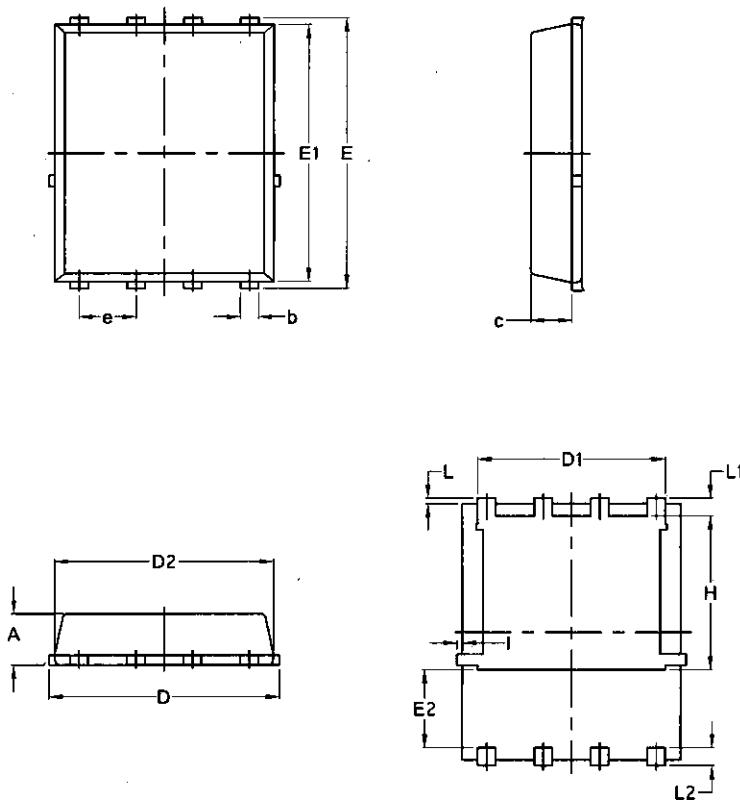
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## Typical Electrical And Thermal Characteristics (Curves)



**Figure 7. Gate Charge Waveforms****Figure 8. Capacitance****Figure 9. Body-Diode Characteristics****Figure 10. Maximum Safe Operating Area**

## Package Mechanical Data-PDFN5060-8L-Single



Symbol	Common			
	mm		Inch	
	Mim	Max	Min	Max
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.0970	0.0324	0.082
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	/	0.18	/	0.0070